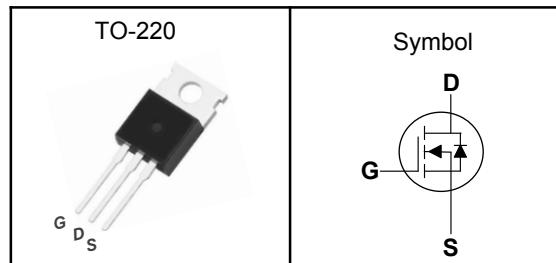


## 600V Super Junction Power MOSFET

### Features

- Low drain-source on-resistance:  $R_{DS(ON)}=0.23\Omega(\text{typ})$
- Easy to control gate switching
- Enhancement mode:  $V_{th} = 2.5 \text{ to } 4.5\text{V}$
- 100% avalanche tested
- RoHS compliant

### Pin Description



### Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply (UPS)
- Power Factor Correction (PFC)
- Charger, Lighting.

$V_{DSS}$	600	V
$R_{DS(ON)-\text{Typ}}$	230	$\text{m}\Omega$
$I_D$	15	A

### Absolute Maximum Ratings ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
$V_{DSS}$	Drain-Source Voltage	600	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	V
$T_J$	Maximum Junction Temperature	-55 to 150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	$^\circ\text{C}$
$E_{AS}$	Single Pulse Avalanche Energy <sup>③</sup>	405	mJ
$I_{DM}^{①}$	Pulse Drain Current Tested	45	A
$I_D$	Continuous Drain Current	$T_c=25^\circ\text{C}$	15
$P_D$	Maximum Power Dissipation	$T_c=25^\circ\text{C}$	118

### Thermal Characteristics

Symbol	Parameter	Rating	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>①</sup>	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>①</sup>	1.06	$^\circ\text{C}/\text{W}$

Note ① : Max. current is limited by bonding wire.

Note ② : UIS tested and pulse width are limited by maximum junction temperature 150°C.

Note ③ : Surface Mounted on 1in<sup>2</sup> FR-4 board with 1oz.

## 600V Super Junction Power MOSFET

### Electrical Characteristics ( $T_J=25^\circ\text{C}$ , Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
<b>Static Electrical Characteristics</b>						
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_{\text{D}}=10\text{mA}$	605	---	---	V
$I_{\text{DS}(\text{ss})}$	Zero Gate Voltage Drain Current	$V_{\text{DS}}=600\text{V}$ , $V_{\text{GS}}=0\text{V}$	---	---	1	$\mu\text{A}$
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{DS}}=V_{\text{GS}}$ , $I_{\text{D}}=250\mu\text{A}$	2.8	---	4.2	V
$I_{\text{GSS}}$	Gate Leakage Current	$V_{\text{GS}}=\pm 30\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	$\text{nA}$
$R_{\text{DS}(\text{ON})}$	Drain-Source On-state Resistance	$V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=7.5\text{A}$	---	230	280	$\text{m}\Omega$
<b>Dynamic Characteristics<sup>⑤</sup></b>						
$C_{\text{iss}}$	Input Capacitance	$V_{\text{GS}}=0\text{V}$ , $V_{\text{DS}}=50\text{V}$ , Freq.=1MHz	---	1020	---	pF
$C_{\text{oss}}$	Output Capacitance		---	98	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	5.1	---	
$T_{\text{d}(\text{on})}$	Turn-on Delay Time	$V_{\text{DD}}=400\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $R_{\text{G}}=10\Omega$ , $I_{\text{D}}=3.8\text{A}$	---	8.4	---	nS
$T_{\text{r}}$	Turn-on Rise Time		---	21.2	---	
$T_{\text{d}(\text{off})}$	Turn-off Delay Time		---	32.2	---	
$T_{\text{f}}$	Turn-off Fall Time		---	20.8	---	
$Q_{\text{g}}$	Total Gate Charge	$V_{\text{DD}}=400\text{V}$ , $V_{\text{GS}}=10\text{V}$ , $I_{\text{D}}=3.8\text{A}$	---	23	---	nC
$Q_{\text{gs}}$	Gate-Source Charge		---	5.7	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	17	---	
<b>Source-Drain Characteristics (<math>T_J=25^\circ\text{C}</math>)</b>						
$V_{\text{SD}}$	Diode Forward Voltage <sub>2</sub>	$V_{\text{GS}}=0\text{V}$ , $I_{\text{S}}=1\text{A}$ , $T_J=25^\circ\text{C}$	---	0.74	---	V
$t_{\text{rr}}$	Reverse Recovery Time	$V_R=400\text{V}$ , $I_S=2\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	216	---	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		---	1.3	---	nC

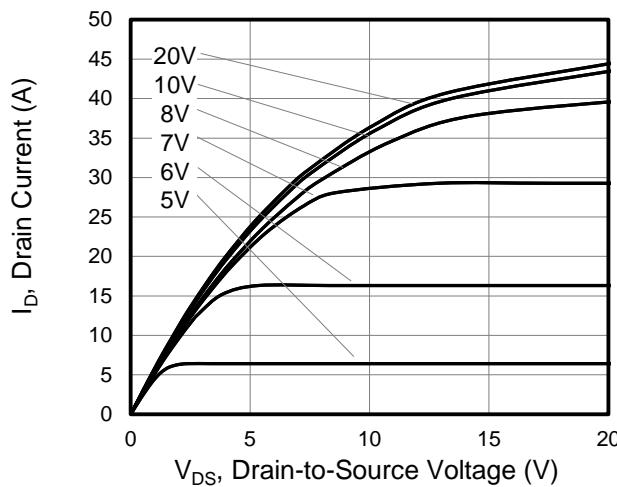
Note ④ : Pulse test (pulse width $\leq 300\mu\text{s}$ , duty cycle $\leq 2\%$ ).

Note ⑤ : Guaranteed by design, not subject to production testing.

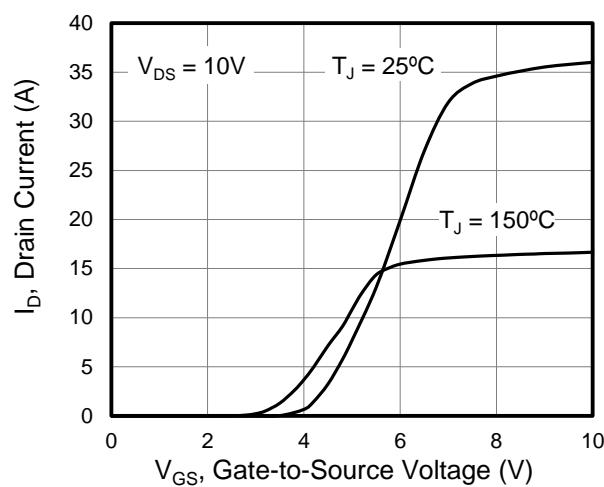
## 600V Super Junction Power MOSFET

### Typical Characteristics

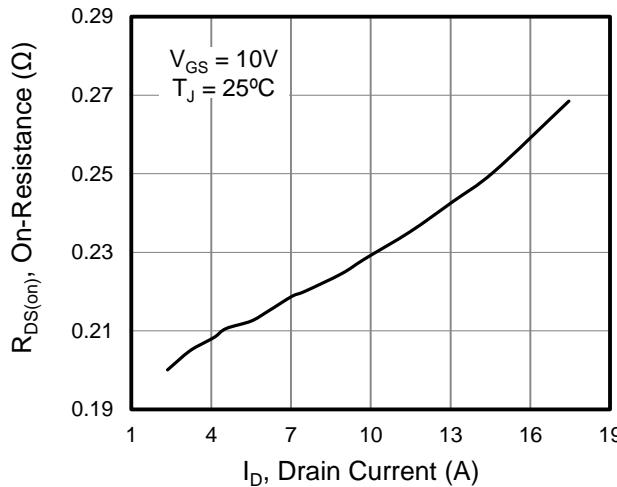
**Figure 1. Output Characteristics**



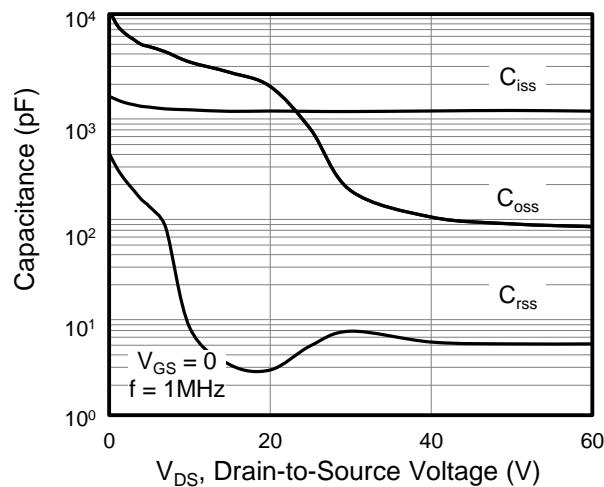
**Figure 2. Transfer Characteristics**



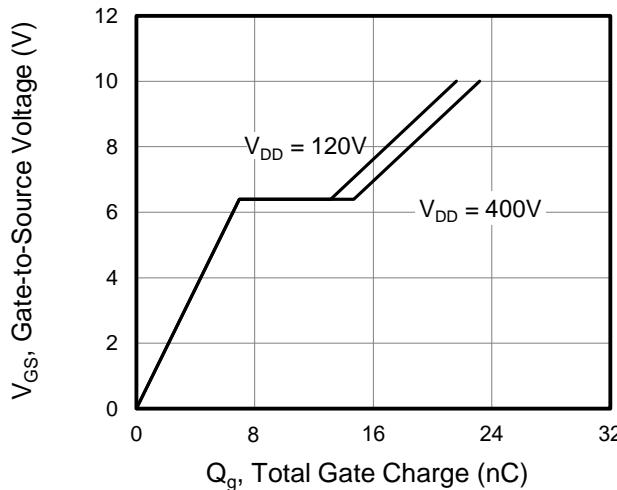
**Figure 3. On-Resistance vs. Drain Current**



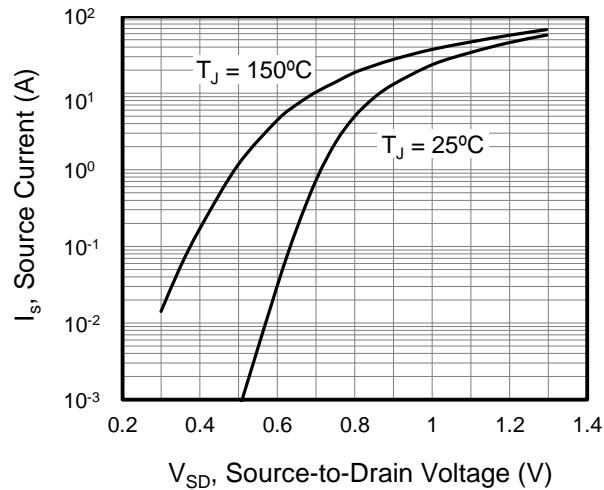
**Figure 4. Capacitance**



**Figure 5. Gate Charge**

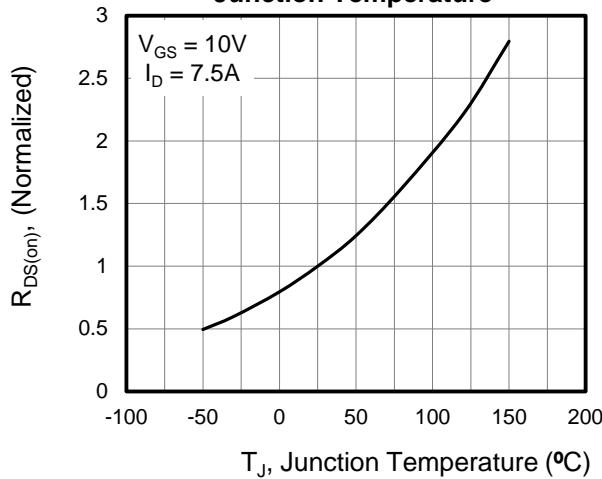


**Figure 6. Body Diode Forward Voltage**

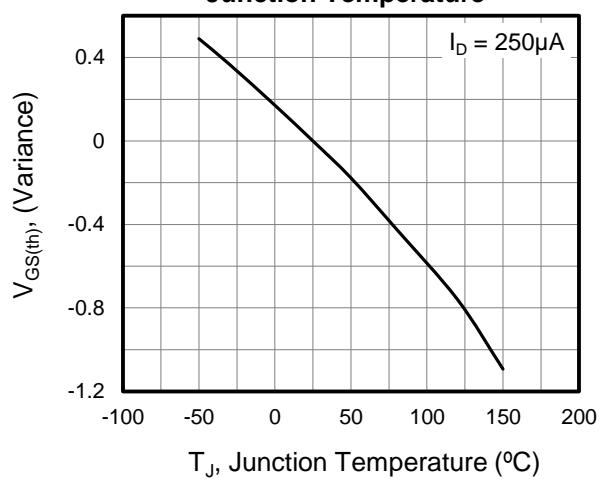


## 600V Super Junction Power MOSFET

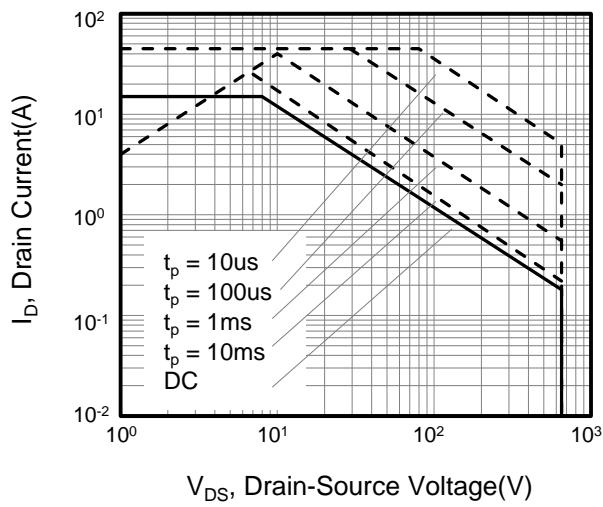
**Figure 7. On-Resistance vs. Junction Temperature**



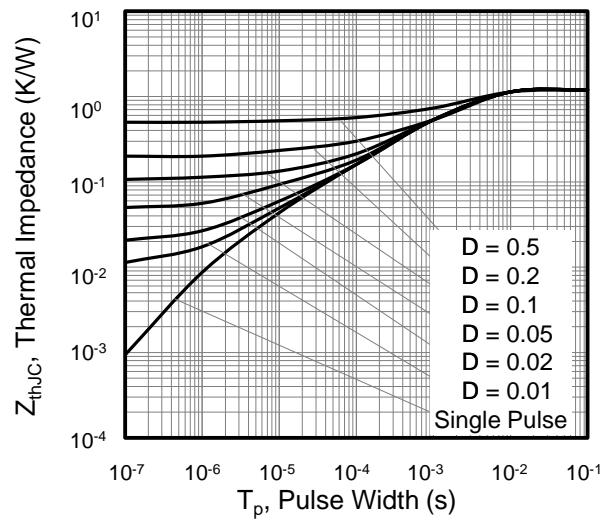
**Figure 8. Threshold Voltage vs. Junction Temperature**



**Figure 9. Safe operation area for**

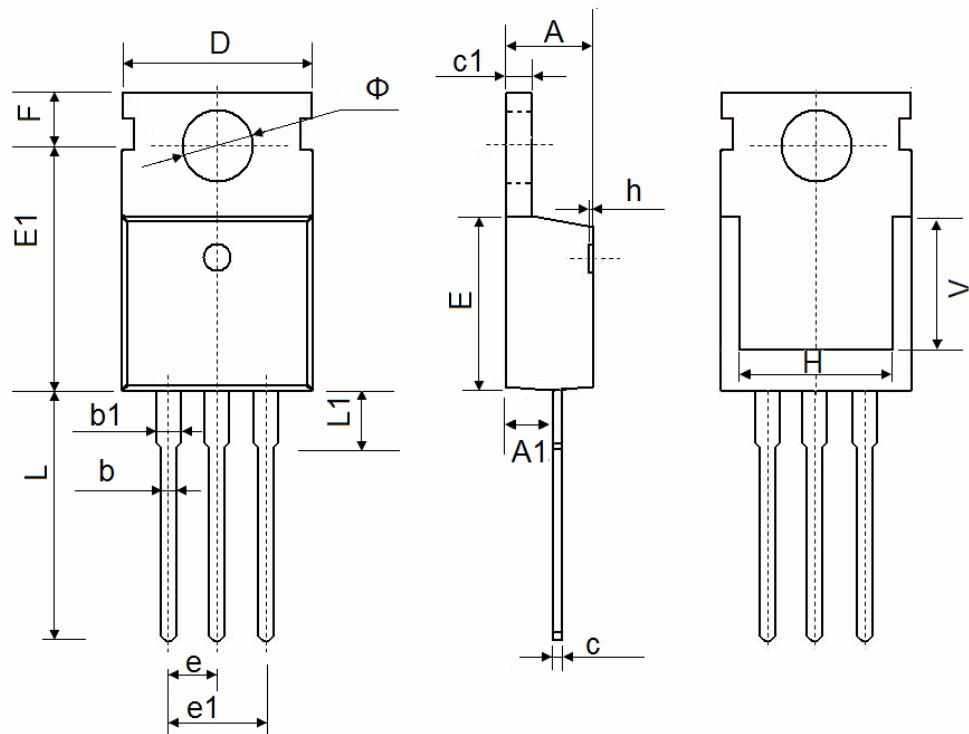


**Figure 10. Transient Thermal Impedance**



## 600V Super Junction Power MOSFET

### TO-220 Package Outline Data



Symbol	Dimensions In Millimeters	
	Min.	Max.
A	4.350	4.650
A1	2.250	2.550
b	0.710	0.910
b1	1.170	1.400
c	0.330	0.650
c1	1.200	1.400
D	9.910	10.250
E	8.9500	9.750
E1	12.650	12.950
e	2.540 TYP.	
e1	4.980	5.180
F	2.650	2.950
H	7.900	8.100
h	0.000	0.300
L	12.700	13.500
L1	2.850	3.250
V	7.500 REF.	
Φ	3.400	3.800